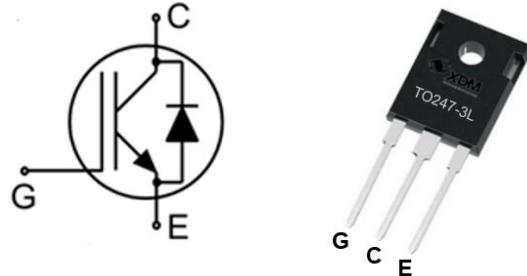


Trench Field-Stop Technology IGBT

Features

- 650V, 50A
- $V_{CE(sat)(typ.)} = 1.8V @ V_{GE}=15V, I_C=50A$
- Maximum Junction Temperature 175°C
- Pb-free Lead Plating; RoHS Compliant



Applications

- Solar Converters
- Uninterrupted Power Supply
- Welding Converters
- Mid to High Range Switching Frequency Converters

Key Performance and Package Parameters

Order codes	V_{CE}	I_C	$V_{CEsat}, T_{vj}=25^\circ C$	T_{vjmax}	Marking	Package
XD050Q065AY1S3	650V	50A	1.8V	175°C	D50Q65AY1	TO247-3L

Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage	650	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Continuous Collector Current ($T_c=25^\circ C$)	100	A
	Continuous Collector Current ($T_c=100^\circ C$)	50	A
I_{CM}	Pulsed Collector Current (Note 1)	200	A
P_D	Maximum Power Dissipation ($T_c=25^\circ C$)	214.3	W
	Maximum Power Dissipation ($T_c=100^\circ C$)	107	W
T_J	Operating Junction Temperature Range	-40 to 175	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Conditions	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case for IGBT	TO247-3L	0.7	°C/W

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted.)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CES}	Collector-Emitter Breakdown Voltage	$V_{\text{GE}}=0\text{V}$, $I_{\text{C}}=200\mu\text{A}$	650	---	---	V
I_{CES}	Collector-Emitter Leakage Current	$V_{\text{CE}}=650\text{V}$, $V_{\text{GE}}=0\text{V}$	---	---	40	μA
I_{GES}	Gate Leakage Current, Forward	$V_{\text{GE}}=20\text{V}$, $V_{\text{CE}}=0\text{V}$	---	---	100	nA
	Gate Leakage Current, Reverse	$V_{\text{GE}}=-20\text{V}$, $V_{\text{CE}}=0\text{V}$	---	---	100	nA
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GE}}=V_{\text{CE}}$, $I_{\text{C}}=500\mu\text{A}$	3.7	4.5	5.3	V
$V_{\text{CE}(\text{sat})}$	Collector-Emitter Saturation Voltage	$V_{\text{GE}}=15\text{V}$, $I_{\text{C}}=50\text{A}$, $T_j=25^\circ\text{C}$	---	1.8	2.2	V
Q_G	Total Gate Charge	$V_{\text{CC}}=520\text{V}$ $V_{\text{GE}}=15\text{V}$ $I_{\text{C}}=50\text{A}$	---	78	---	nC
Q_{GE}	Gate-Emitter Charge		---	12.5	---	nC
Q_{GC}	Gate-Collector Charge		---	45	---	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{CC}}=400\text{V}$ $V_{\text{GE}}=\pm 15\text{V}$ $I_{\text{C}}=50\text{A}$ $R_{\text{G}}=20\Omega$ Inductive Load $T_c=25^\circ\text{C}$	---	15.3	---	ns
t_r	Turn-on Rise Time		---	50.7	---	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		---	153	---	ns
t_f	Turn-off Fall Time		---	73.6	---	ns
E_{on}	Turn-on Switching Loss		---	0.47	---	mJ
E_{off}	Turn-off Switching Loss		---	0.72	---	mJ
E_{ts}	Total Switching Loss		---	1.19	---	mJ
C_{ies}	Input Capacitance	$V_{\text{CE}}=25\text{V}$ $V_{\text{GE}}=0\text{V}$ $f=1\text{MHz}$	---	1230	---	pF
C_{oes}	Output Capacitance		---	132	---	pF
C_{res}	Reverse Transfer Capacitance		---	39	---	pF

Diode Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=50\text{A}$, $T_j=25^\circ\text{C}$	---	1.65	2.2	V
t_{rr}	Diode Reverse Recovery Time	$VR=400\text{V}$ $I_F=50\text{A}$ $dI_F/dt=350\text{A/us}$ $T_c=25^\circ\text{C}$	---	146.2	---	ns
I_{rr}	Diode peak Reverse Recovery Current		---	7.9	---	A
Q_{rr}	Diode Reverse Recovery Charge		---	392	---	nC

Note1: Repetitive rating, pulse width limited by maximum junction temperature

Typical Characteristics

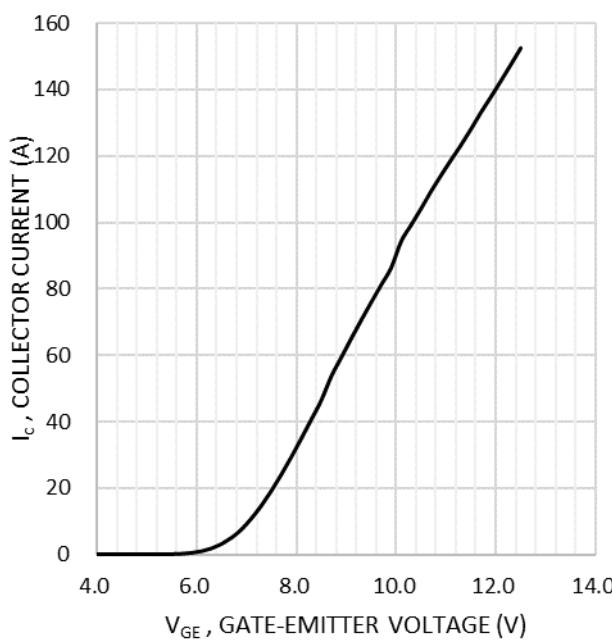


Fig. 1 Typical transfer characteristics
($V_{CE}=20V$)

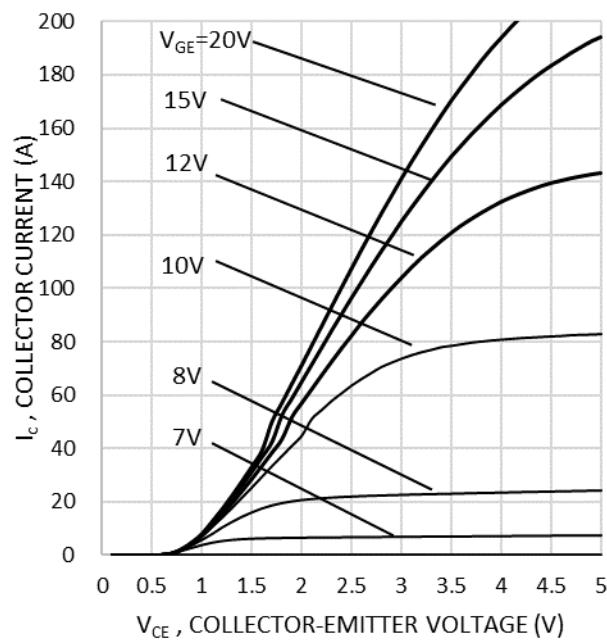


Fig. 2 Typical output characteristic ($T_{vj}=25^{\circ}\text{C}$)

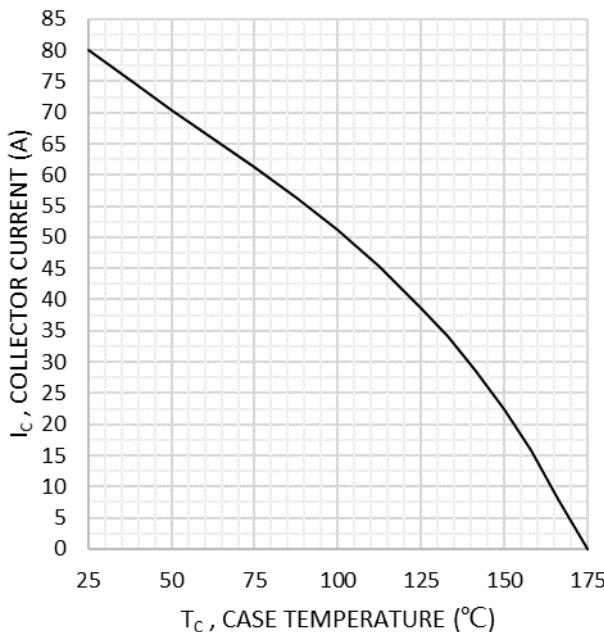


Fig. 3 Collector current as a function of case temperature ($V_{GE}\geq 15\text{V}$, $T_{vj}\leq 175^{\circ}\text{C}$)

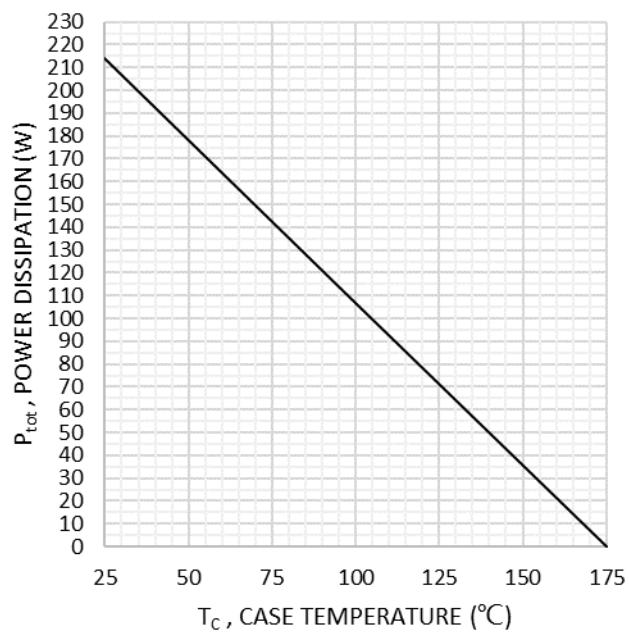


Fig. 4 Power dissipation as a function of case temperature ($T_{vj}\leq 175^{\circ}\text{C}$)

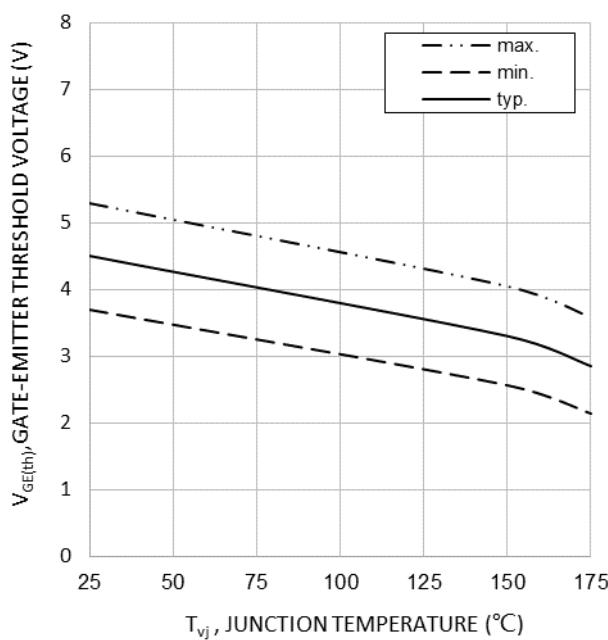


Fig. 5 Gate-emitter threshold voltage as a function of junction temperature ($I_c=0.40\text{mA}$)

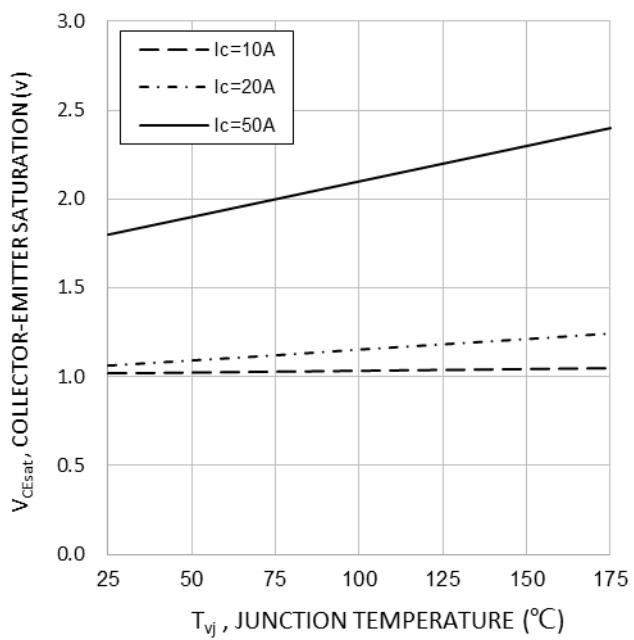


Fig. 6 Typical collector-emitter saturation voltage as a function of junction temperature ($V_{GE}=15\text{V}$)

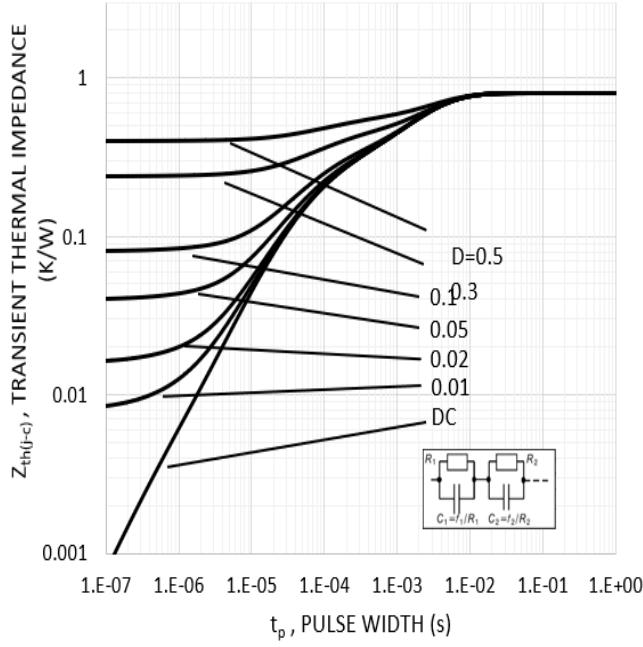


Fig. 7 IGBT transient thermal impedance ($D=t_p/T$)

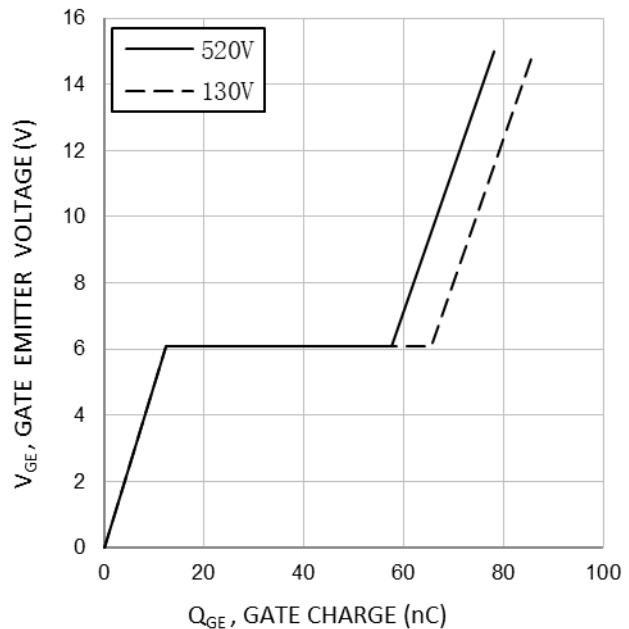
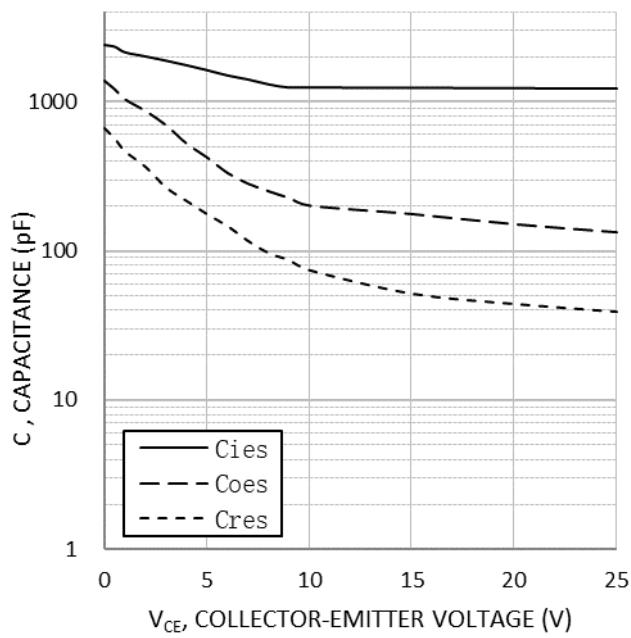


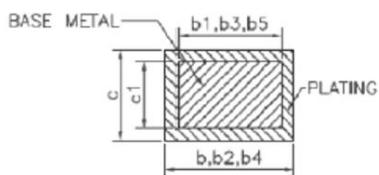
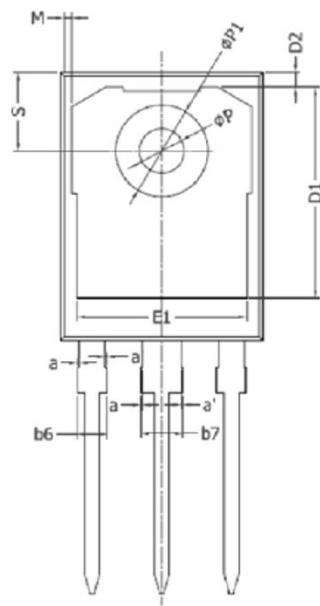
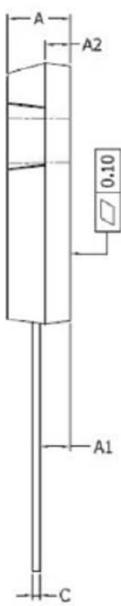
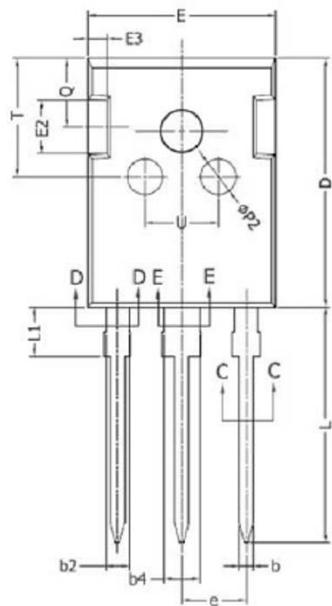
Fig. 8 Typical gate charge ($I_c=50\text{A}$)



**Fig. 9 Typical capacitance as a function of
collector-emitter voltage ($V_{GE}=0V$, $f=1MHz$)**

Package Information

TO-247-3L



SECTION C-C,D-D & E-E

SYMBOL	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0	—	0.15
a'	0	—	0.15
b	1.16	—	1.26
b1	1.15	1.2	1.22
b2	1.96	—	2.06
b3	1.95	2.00	2.02
b4	2.96	—	3.06
b5	2.96	3.00	3.02
b6	---	—	2.25
b7	---	—	3.25
c	0.59	—	0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	1.50	1.60	1.70
e	5.436 BSC		
L	19.80	19.92	20.10
L1	---	—	4.30
M	0.35	—	0.95
P	3.40	3.50	3.60
P1	7.00	—	7.40
P2	2.40	2.50	2.60
Q	5.60	—	6.00
S	6.05	6.15	6.25
T	9.80	—	10.20
U	6.00	—	6.40